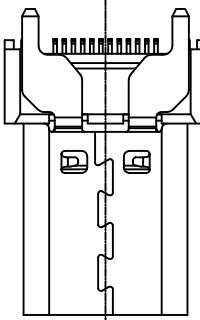
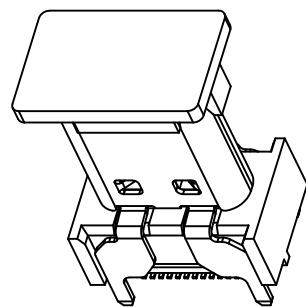
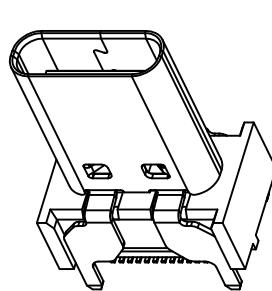




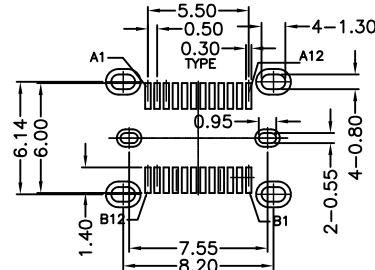
| REV. | ZONE | DESCRIPTION | DESIGN | DATE |
|------|------|-------------|--------|------|
| B | | NEW | | |



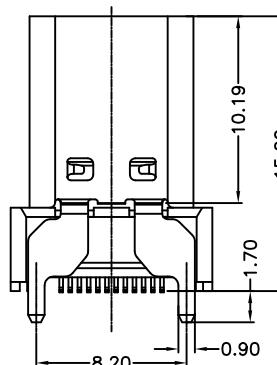
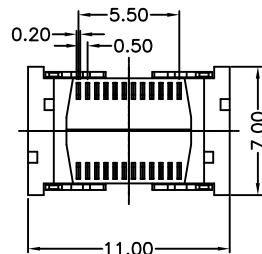
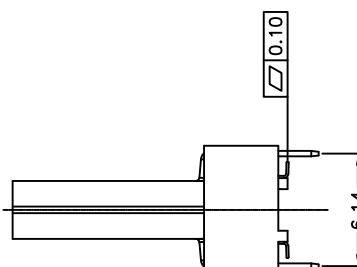
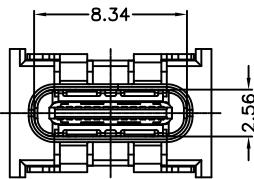
WITHOUT COVER



WITH COVER

RECOMMEND P.C.B LAYOUT(COMPONENT SIDE)TOLERANCE FOR PCB LAYOUT IS ± 0.05

KEEP OUT AREA



| Item | Title | Material | Dispose | Remark |
|------|----------------|--------------------------|------------------------|--------|
| 1 | Shell | Stainless Steel | Ni:30μ Min. | |
| 2 | GND Plate | Stainless Steel | | |
| 3 | Mid Plate | Stainless Steel | Solder Tails: Matt Tin | |
| 4 | Top Contact | Copper Alloy | Mating Area: See P/N | |
| 5 | Bottom Contact | Copper Alloy | Solder Tails: Matt Tin | |
| 6 | Insulator | High Temperature Plastic | UL 94V-0 | Black |

- Contact Resistance: 40mΩ Max.;
- Dielectric Withstanding Voltage: 100V AC For 1 Minute;
- Insulation Resistance: 100M OHM Min.;
- Mating And Unmating Force:
 - Mating Force: 5~20N
 - Unmating Force: 8~20N(0~1000cycle);
6~20N(1001~10000cycle);
- Durability: 10000 Cycles;

| | | | | | |
|-----------------|---------------------|-------------|---|------|----------|
| X. ± 0.50 | X. $\pm 2^\circ$ | UNITS mm | 深圳市富港科技有限公司 | | |
| .X ± 0.30 | .X $\pm 1^\circ$ | MATL | TITLE: TYPE-C 24PIN立式贴片母座 高度H=15.0MM | | |
| .XX ± 0.10 | .XX $\pm 0.5^\circ$ | | APPD: | | DWG NO.: |
| .XXX ± 0.05 | | FINISH | | | |
| | | | CHKD: | | |
| | | | DR: | | |
| | | SCALE | HEET | REV. | |
| | | 1/1 | 1/1 | A1 | |